

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7402659

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| GUANGSU SHAO | 06/09/2022 |
| DEYUAN XIAO | 06/13/2022 |
| YUNSONG QIU | 06/20/2022 |
| YOUMING LIU | 06/13/2022 |
| YI JIANG | 06/13/2022 |
| XINGSONG SU | 06/24/2022 |
| YUHAN ZHU | 06/14/2022 |
| RECEIVING PARTY DATA | |
| Name: | CHANGXIN MEMORY TECHNOLOGIES, INC. |
| Street Address: | NO. 388, XINGYE AVENUE, AIRPORT INDUSTRIAL PARK |
| Internal Address: | ECONOMIC AND TECHNOLOGICAL DEVELOPMENT AREA |
| City: | HEFEI CITY, ANHUI |
| State/Country: | CHINA |
| Postal Code: | 230000 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 17809092 |
| CORRESPONDENCE DATA | |
| Fax Number: | (216)373-3450 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 12166540090 |
| Email: | docketing@cooperlegalgroup.com |
| Correspondent Name: | COOPER LEGAL GROUP LLC |
| Address Line 1: | 1388 RIDGE ROAD, UNIT 1 |
| Address Line 4: | HINCKLEY, OHIO 44233 |
| ATTORNEY DOCKET NUMBER: | BOXP484WOUS |
| NAME OF SUBMITTER: | MARCUS A. FISCHER |
| SIGNATURE: | /Marcus A. Fischer/ |

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|---|------------|
| DATE SIGNED: | 06/27/2022 |
| Total Attachments: 14 source=DeclarationAssignment#page1.tif source=DeclarationAssignment#page2.tif source=DeclarationAssignment#page3.tif source=DeclarationAssignment#page4.tif source=DeclarationAssignment#page5.tif source=DeclarationAssignment#page6.tif source=DeclarationAssignment#page7.tif source=DeclarationAssignment#page8.tif source=DeclarationAssignment#page9.tif source=DeclarationAssignment#page10.tif source=DeclarationAssignment#page11.tif source=DeclarationAssignment#page12.tif source=DeclarationAssignment#page13.tif source=DeclarationAssignment#page14.tif | |

**DECLARATION AND ASSIGNMENT
FOR PATENT AND DESIGN APPLICATIONS**

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| Title of Invention | SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF |
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As the below named inventor, I, hereinafter referred to as the undersigned, hereby declare that:

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- ☐ the attached application, or
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Whereas, I have invented certain new and useful improvements in the application identified above; and

Whereas,

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No. 388, Xingye Avenue, Airport Industrial Park, Economic And Technological
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hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in and to said invention as described in the application identified above, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

Now, therefore, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned has sold and assigned, and by these presents hereby sells

and assigns, unto said assignee its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the invention identified above, including said application for United States Letters Patent, all divisional, renewal, substitute, continuation, nonprovisionals, continuation-in-parts, and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues, reexaminations, and extensions of Letters Patent granted for said inventions or upon said applications and every priority right that is or may be predicated upon or arise from said inventions, said applications, and said Letters Patent; said Assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said Assignee or otherwise as said Assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America being hereby authorized to issue or transfer all said Letters Patent to said Assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right theretofore given, and that the undersigned will do all acts reasonably serving to ensure that the said inventions, patent applications and Letters Patent shall be held and enjoyed by said Assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said Assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, declarations, and lawful affidavits in form and substance which may be requested by said Assignee, to furnish said Assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may embody said inventions, and to testify in any proceedings relating to said inventions, patent applications, and/or Letters Patent.

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LEGAL NAME OF INVENTORS:

Guangsu SHAO (Signature)
Inventor: Guangsu SHAO

Date: 2022.06.09

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LEGAL NAME OF INVENTORS:

Deyuan Xiao (Signature)
Inventor: Deyuan XIAO

Date: June 13, 2022

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LEGAL NAME OF INVENTORS:

Yunsong Qiu (Signature)
Inventor: Yunsong QIU

Date: June 23, 2022

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LEGAL NAME OF INVENTORS:

Lin Youming (Signature)
Inventor: YOUMING LIU

Date: 2022.6.13

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LEGAL NAME OF INVENTORS:

Jiang Yi (Signature)
Inventor: YI JIANG

Date: 6/13 - 2022

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LEGAL NAME OF INVENTORS:

Xingsong SU (Signature)
Inventor: Xingsong SU

Date: 6/24/2022

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hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in and to said invention as described in the application identified above, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

Now, therefore, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned has sold and assigned, and by these presents hereby sells

and assigns, unto said assignee its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the invention identified above, including said application for United States Letters Patent, all divisional, renewal, substitute, continuation, nonprovisionals, continuation-in-parts, and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues, reexaminations, and extensions of Letters Patent granted for said inventions or upon said applications and every priority right that is or may be predicated upon or arise from said inventions, said applications, and said Letters Patent; said Assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said Assignee or otherwise as said Assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America being hereby authorized to issue or transfer all said Letters Patent to said Assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right theretofore given, and that the undersigned will do all acts reasonably serving to ensure that the said inventions, patent applications and Letters Patent shall be held and enjoyed by said Assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said Assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, declarations, and lawful affidavits in form and substance which may be requested by said Assignee, to furnish said Assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may embody said inventions, and to testify in any proceedings relating to said inventions, patent applications, and/or Letters Patent.

This Assignment is deemed to be effective at least as early as the earliest priority date.

The undersigned hereby grant(s) an authorized representative of Assignee the power to insert in this Assignment the application number and filing date and any further identification that may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

LEGAL NAME OF INVENTORS:

Yuhan Zhu (Signature)
Inventor: Yuhan ZHU

Date: 6/14/2022